

<b>PATENT ASSIGNMENT COVER SHEET</b>
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Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT8128750

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MINHOON LEE	08/22/2023
GYONYUN KIM	08/22/2023
JUNGJIN KIM	08/22/2023
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SAMSUNG ELECTRONICS CO., LTD.
<b>Street Address:</b>	129, SAMSUNG-RO, YEONGTONG-GU
<b>City:</b>	SUWON-SI, GYEONGGI-DO
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	16677
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	18237054
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(202)434-1501
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	(202)434-1500
<b>Email:</b>	dkinnier@s-n-h.com
<b>Correspondent Name:</b>	STAAS & HALSEY, LLP
<b>Address Line 1:</b>	1201 NEW YORK AVENUE, NW
<b>Address Line 2:</b>	SUITE 700
<b>Address Line 4:</b>	WASHINGTON, D.C. 20005
<b>ATTORNEY DOCKET NUMBER:</b>	1904.1621
<b>NAME OF SUBMITTER:</b>	TEMNIT AFEWORK
<b>SIGNATURE:</b>	/Temnit Afework/
<b>DATE SIGNED:</b>	08/23/2023
<b>Total Attachments: 1</b>	
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